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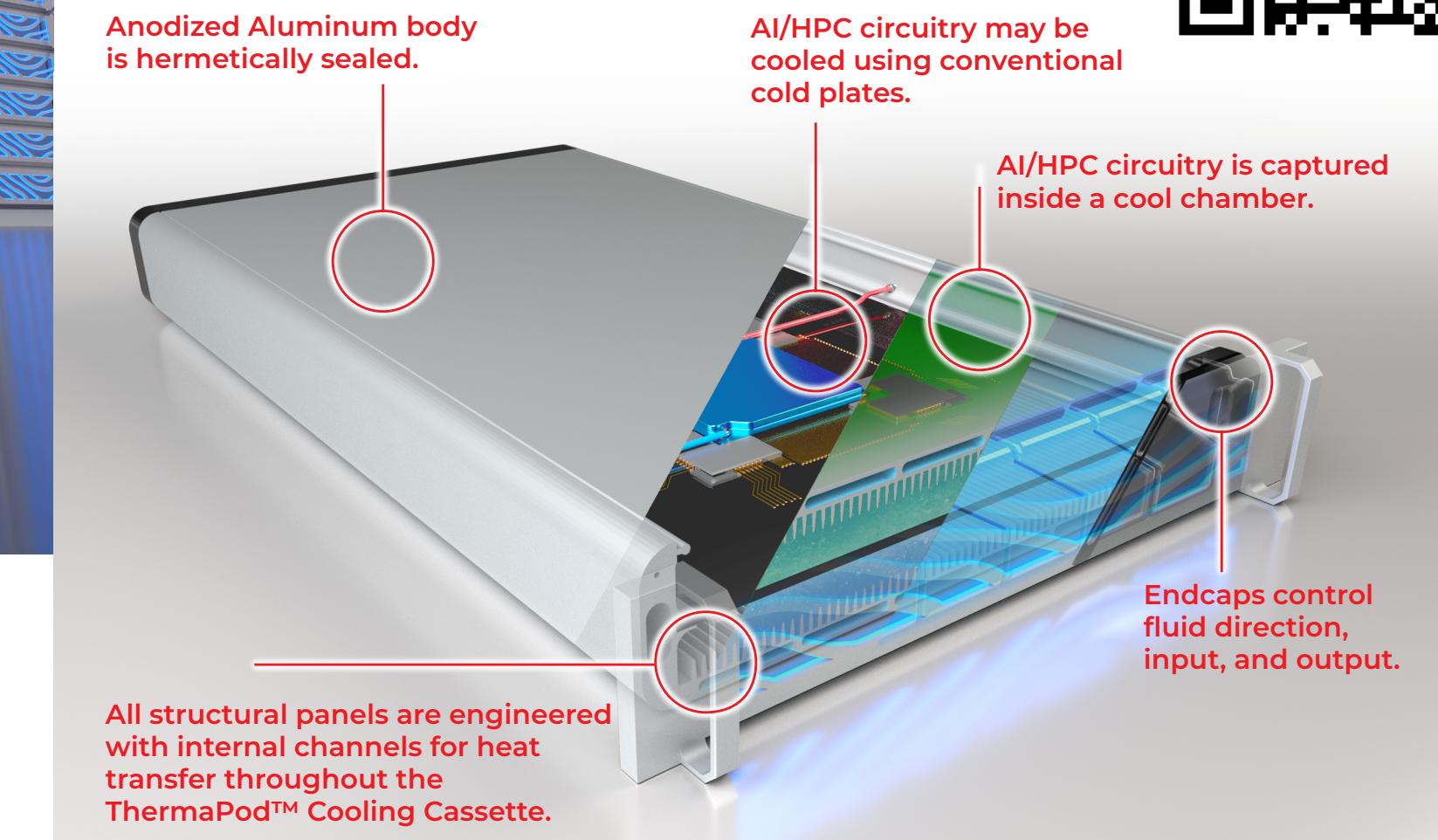
THE ThermaPod™

Modular/Adaptable Cooling Cassette

- Hermetically Sealed
- AI/HPC Cooling Cassette
- Versatile, Scalable, and Future-Proof.

Modes & Panel Role

1. Two-Phase Immersion – Roof = primary condenser; other panels assist.
2. Two-Phase Spray Roof = primary condenser; other panels assist.
3. Direct-to-Chip (Indirect) Roof = micro AC; other panels manage liquid cooling.



All Graphic content created by
Jeff Rhodes, Industrial-Designs.com.

A NEW WAY TO GET COOL.



Facility-to-Chip Control



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THE **Borealis™ CDU** One Platform, Three Operating Modes

- Modular & Scalable — Expands in 2-pump or 3-pump modules, orchestrating single-phase, two-phase, or hybrid loops.
- Facility-to-Chip™ Ready — Integrates with BAS/DCIM and rack endpoints (cold-plate, immersion, spray).
- Service-Friendly — Front/back access, isolation valves, and online filtration for easy maintenance.

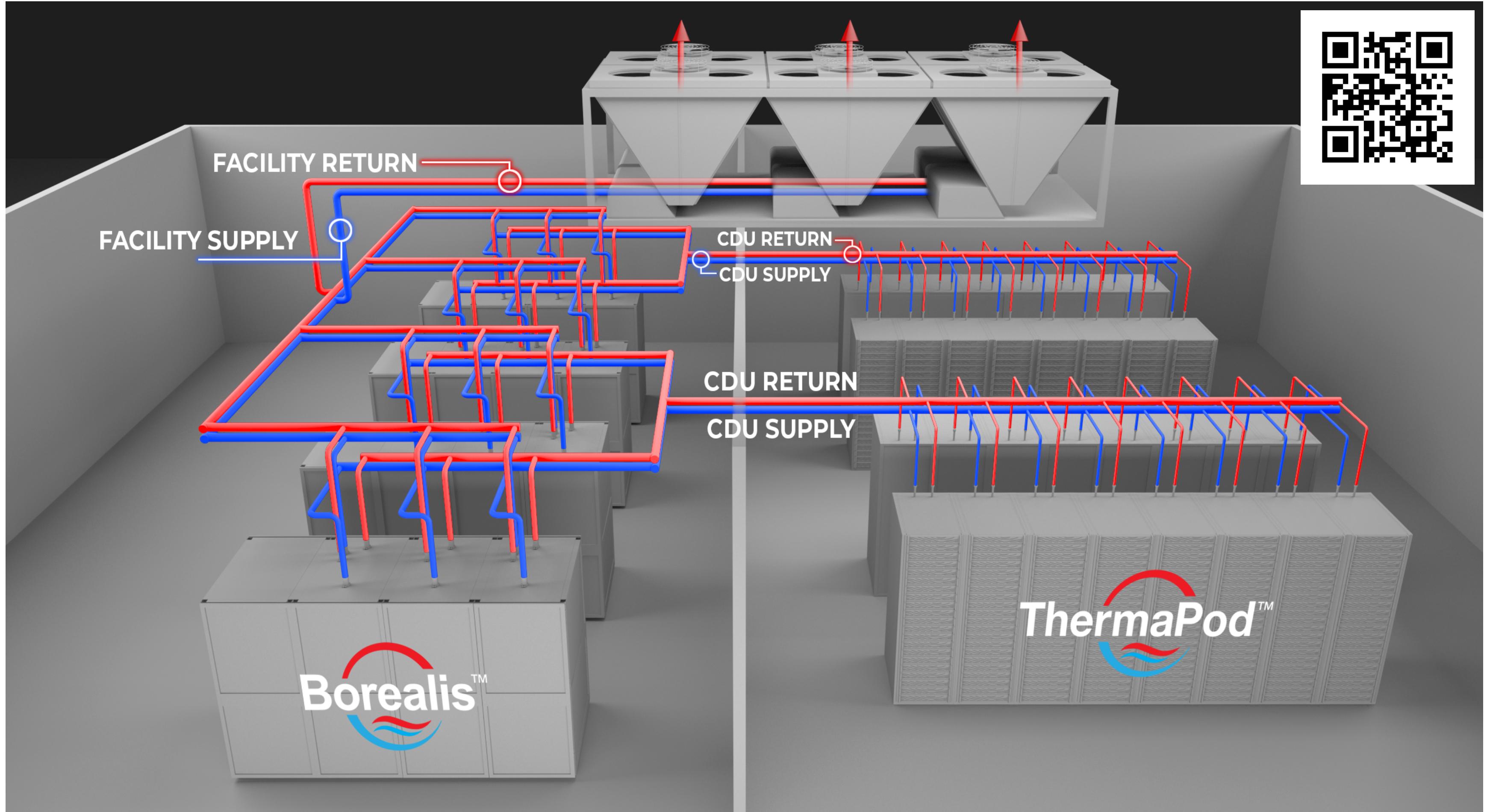
Operation Modes

- Mode A – Single-Phase (Water/PG)
Mode B – Two-Phase (Dielectric)
Mode C – Hybrid (Dual-Medium)



Scalable – Designed to Connect.

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A NEW MODULAR / SCALABLE / ADAPTABLE
WAY TO **FUTURE-PROOF** AI / DATA CENTER COOLING.